

Title (en)  
COMPOUNDS WITH SPIROBIFLUORENE-STRUCTURES

Title (de)  
VERBINDUNGEN MIT SPIROBIFLUOREN-STRUKTUREN

Title (fr)  
COMPOSÉS À STRUCTURES SPIROBIFLUORÈNE

Publication  
**EP 3430006 A1 20190123 (DE)**

Application  
**EP 17710010 A 20170315**

Priority  
• EP 16160960 A 20160317  
• EP 2017056064 W 20170315

Abstract (en)  
[origin: WO2017157983A1] The invention relates to spirobifluorene derivatives which are substituted with pyridine and/or pyrimidine groups, in particular for use in electronic devices. The invention further relates to a method for producing the compounds according to the invention, and to electronic devices comprising the same.

IPC 8 full level  
**C07D 403/04** (2006.01); **C07D 213/16** (2006.01); **C07D 213/22** (2006.01); **C07D 239/26** (2006.01); **C07D 403/14** (2006.01); **C07D 405/04** (2006.01); **C07D 405/10** (2006.01); **C07D 409/04** (2006.01); **H01L 51/00** (2006.01)

CPC (source: EP KR US)  
**C07D 213/16** (2013.01 - EP KR US); **C07D 213/22** (2013.01 - EP KR US); **C07D 239/26** (2013.01 - EP KR US); **C07D 403/04** (2013.01 - EP KR US); **C07D 403/14** (2013.01 - EP KR US); **C07D 405/04** (2013.01 - EP KR US); **C07D 405/10** (2013.01 - EP KR US); **C07D 409/04** (2013.01 - EP KR US); **C09K 11/02** (2013.01 - US); **C09K 11/06** (2013.01 - US); **H10K 50/00** (2023.02 - US); **H10K 85/615** (2023.02 - EP KR US); **H10K 85/626** (2023.02 - EP US); **H10K 85/654** (2023.02 - EP KR US); **H10K 85/6572** (2023.02 - EP KR US); **H10K 85/6574** (2023.02 - EP KR US); **H10K 85/6576** (2023.02 - EP KR US); **H10K 50/12** (2023.02 - US); **H10K 50/18** (2023.02 - EP KR US); **Y02E 10/549** (2013.01 - EP KR US)

Designated contracting state (EPC)  
AL AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HR HU IE IS IT LI LT LU LV MC MK MT NL NO PL PT RO RS SE SI SK SM TR

Designated extension state (EPC)  
BA ME

DOCDB simple family (publication)  
**WO 2017157983 A1 20170921**; CN 108779103 A 20181109; CN 108779103 B 20211228; EP 3430006 A1 20190123; JP 2019513133 A 20190523; JP 2022078024 A 20220524; JP 7073267 B2 20220523; KR 102402723 B1 20220527; KR 20180127639 A 20181129; TW 201808917 A 20180316; TW 202212326 A 20220401; TW I745361 B 20211111; TW I821807 B 20231111; US 2019106391 A1 20190411

DOCDB simple family (application)  
**EP 2017056064 W 20170315**; CN 201780017455 A 20170315; EP 17710010 A 20170315; JP 2018548708 A 20170315; JP 2022014430 A 20220201; KR 20187029615 A 20170315; TW 106108384 A 20170314; TW 110144886 A 20170314; US 201716085752 A 20170315